

## • Surface-mount 3.0 x 3.0 x 1.3 mm Package

Complies with Directive 2002/95/EC (RoHS)



### **Absolute Maximum Ratings**

Rating	Value	Units
Input Power Level	10	dBm
DC Voltage on any Non-ground Terminal	3	V
Operable Temperature Range	-45 to +125	°C
Specification Temperature Range	-25 to +75	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Solder Reflow Temperature, 10 seconds, 5 cycles maximum	260	°C



SF2205E

879 MHz

SM3030-6

#### **Electrical Characteristics**

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency				879		MHz
Maximum Insertion Loss, 864 to 894 MHz	IL				3.5	dB
Amplitude Ripple, 864 to 894 MHz					2.0	dB <sub>P-P</sub>
I/O Return Loss, 864 to 894 MHz			10			dB
Attenuation Referenced to 0 dB:						
10 to 840 MHz			40			
920 to 1000 MHz			30			dB
1000 to 2600 MHz		25				
Source Impedance	Z <sub>S</sub>			50		Ω
Load Impedance	ZL			50		<u> </u>
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	937, <u>YWWS</u>					
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel					
Reel Size 13 Inch	3000 Pieces/Reel					

## **Electrical Connections**

Connection	Terminals
Input	5
Output	2
Ground	All Others

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance methyling depined to the Net Net Ale of details. 1.

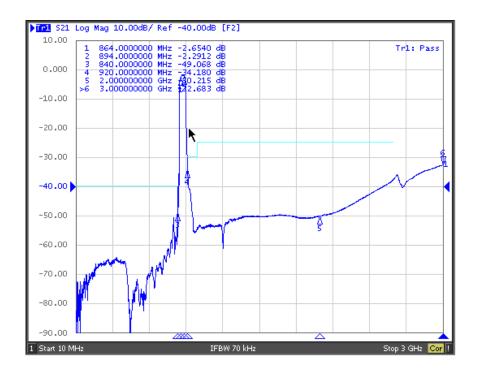
2. 3.

Rejection is measured as attenuation below the minimum it point in the passuand. Rejection in manuser application is dependent on restriction of the layest and external impedance matching design. See Application Note No. 42 for details. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes." The design, manufacturing process, and specifications of this filter are subject to change. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design. 4.

5. 6.

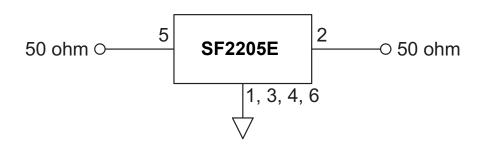
7.

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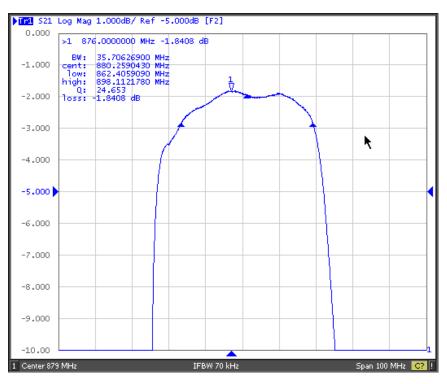


# Filter Broadband Response, 10 to 3000 MHz

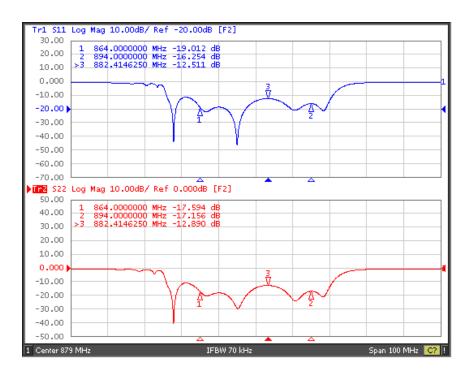
**Filter Test Circuit** 



# Filter Passband Plot, 829 to 929 MHz

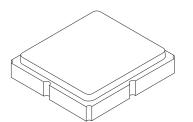


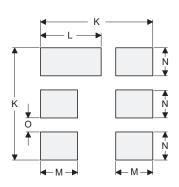
# Filter I/O Return Loss Plots, 829 to 929 MHz



# SM3030-6 Case

# 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





**PCB** Footprint Top View

Dimension		mm		Inches		
Dimension	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.00	3.13	0.113	0.118	0.123
В	2.87	3.00	3.13	0.113	0.118	0.123
С	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
н	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
К		3.20			0.126	
L		1.70			0.067	
М		1.05			0.041	
N		0.81			0.032	
0		0.38			0.015	

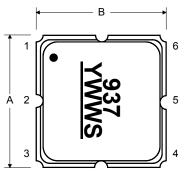
# **Case and PCB Footprint Dimensions**

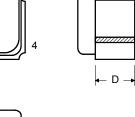
## **Case Materials**

С

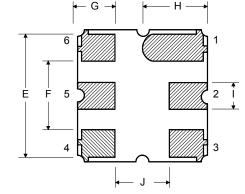
Materials					
Solder Pad Plating	0.3 to 1.0 $\mu m$ Gold over 1.27 to 8.89 $\mu m$ Nickel				
Lid Plating	2.0 to 3.0 µm Nickel				
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic				
Pb Free					

**TOP VIEW** 



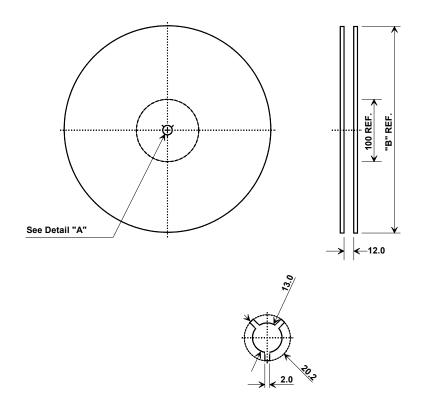






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## **Tape and Reel Specifications**



"	'B"	Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000

## **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions					
Ао	3.35 mm				
Во	3.35 mm				
Ко	1.40 mm				
Pitch	8.0 mm				
W	12.0 mm				

